

Electronic Acknowledgement Receipt

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Title of Invention:	Multilayer substrate with built-in-chip-type electronic component and method for manufacturing the same
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File Listing:

Document Number	Document Description	File Name	File Size(Bytes) /Message Digest	Multi Part /.zip	Pages (if appl.)
1	NPL Documents	36856-1458-Prior_Art-20070924-korean-search-report.pdf	296795 1dc85dfdb88d08d0eed90ff56e35edca91a1408	no	8

Warnings:

Information:					
2	Information Disclosure Statement (IDS) Filed	36856-1458-PTO-20071015-US_IDS_Form_SB_08a.pdf	779337 a98f568cbfb5f94eedddff1bf06e1349861 a21320	no	4
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